



OLED DISPLAY MODULE DATASHEET



Datasheet Release Date 2020-01-17 for
CFAL12864N-A-B4

Revision 1.2

CrystalFontz America, Inc.

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1. General Information

Datasheet Revision History

Datasheet Release: **2020-01-17**
Datasheet for the CFAL12864N-A-B4 OLED graphic display module.

Product Change Notifications

You can check for or subscribe to [Part Change Notices](#) for this display module on our website.

Variations

Slight variations between lots are normal (e.g., contrast, color, or intensity).

Volatility

This display module has volatile memory.

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2. Module Description

This is a dual color, yellow and blue, OLED display module with high resolution. This display has a built-in Solomon Systech SSD1306 controller that can interface in 6800 or 8080 parallel, I2C, or SPI. The Solomon Systech SSD1306 controller only requires a single 3.3v supply for power and logic, the panel requires a separate voltage for OLED operation.

Please see [Solomon Systech SSD1306 LCD Controller Datasheet](#) for further reference.

3. Features

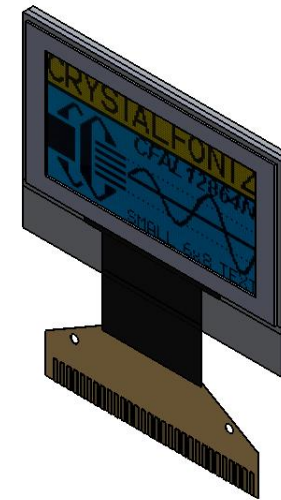
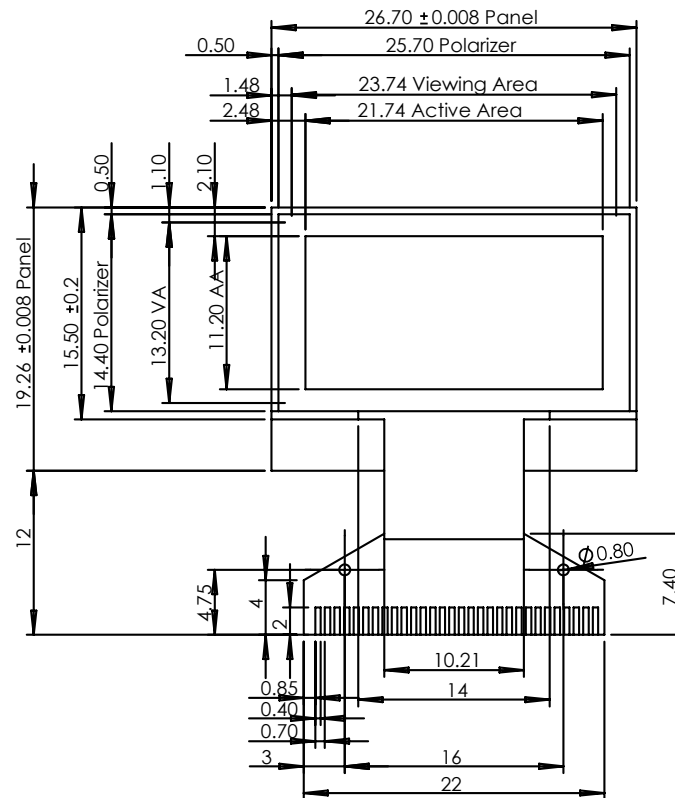
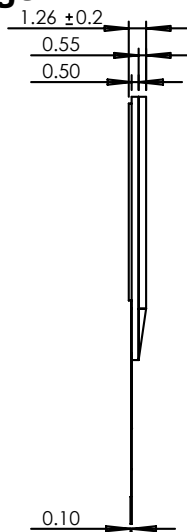
- 128*64 Dot Matrix
- Built-in Controller: SSD1306 (or equivalent)
- 3V Logic Power Supply plus OLED Power Supply
- 1/64 Duty
- Operating Temperature: -40° to +80°C
- Storage Temperature: -40° to +85°C
- Interface: I²C, 3-wire SPI, 4-wire SPI

4. Mechanical Data

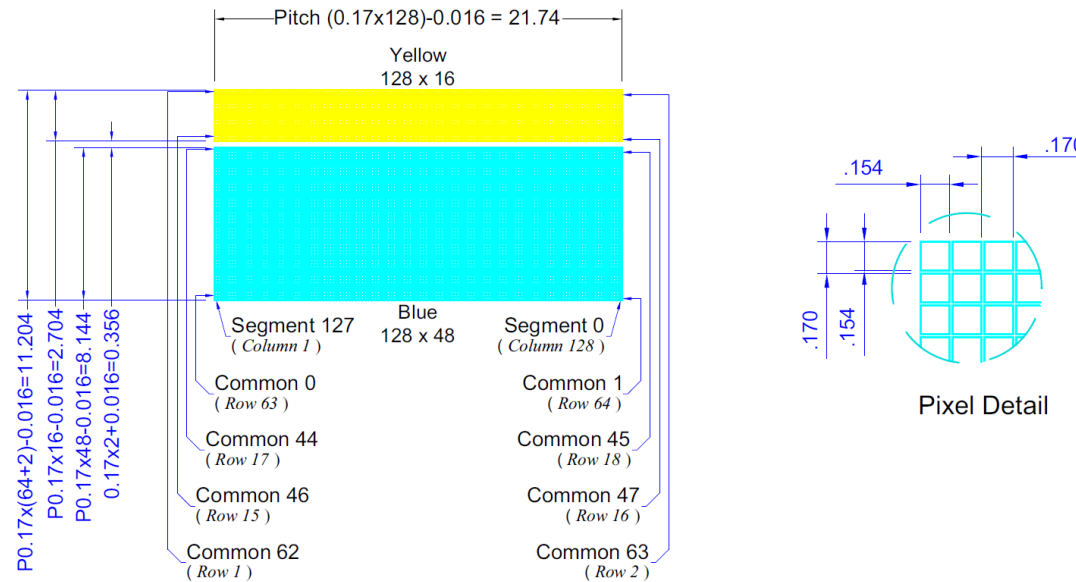
Item	Specification (mm)	Specification (inches, reference)
Module Dimension	26.7 (W) x 19.26 (H) x 1.26 (D)	1.051 (W) x 0.758 (H) x 0.050 (D)
Viewing Area	23.74 (W) x 13.20 (H)	0.935 (W) x 0.519 (H)
Active Area	21.74 (W) x 11.20 (H)	0.856 (W) x 0.441 (H)
Dot Pitch	0.17 (W) x 0.17 (H)	0.007 (W) x 0.007 (H)
Dot Size	0.148 (W) x 0.148 (H)	0.006 (W) x 0.006 (H)
Weight (Typical)	2 grams	0.071 ounces


5. Mechanical Drawings

Pin	Symbol
1	GND
2	C2N
3	C2P
4	C1P
5	C1N
6	VBAT
7	NC
8	VSS(GND)
9	VLogic
10	BS0
11	BS1
12	BS2
13	CS#
14	RES#
15	D/C#
16	R/W#
17	E/RD#
18-25	D0-D7
26	IREF
27	VCOMH
28	VOLED
29	VLSS
30	GND



Units: millimeters
Tolerance: ±0.3



 <p>Copyright © 2016 by Crystalfontz America, Inc. www.crystalfontz.com/products/</p>	<p>Part No.(s): CFAL12864N-A-B4</p>	<p>Scale: Not to scale</p>	<p>Drawing Number: CFAL12864N-A-B4</p>
		<p>Units: Millimeters</p>	<p>Date: 2017-07-21</p>

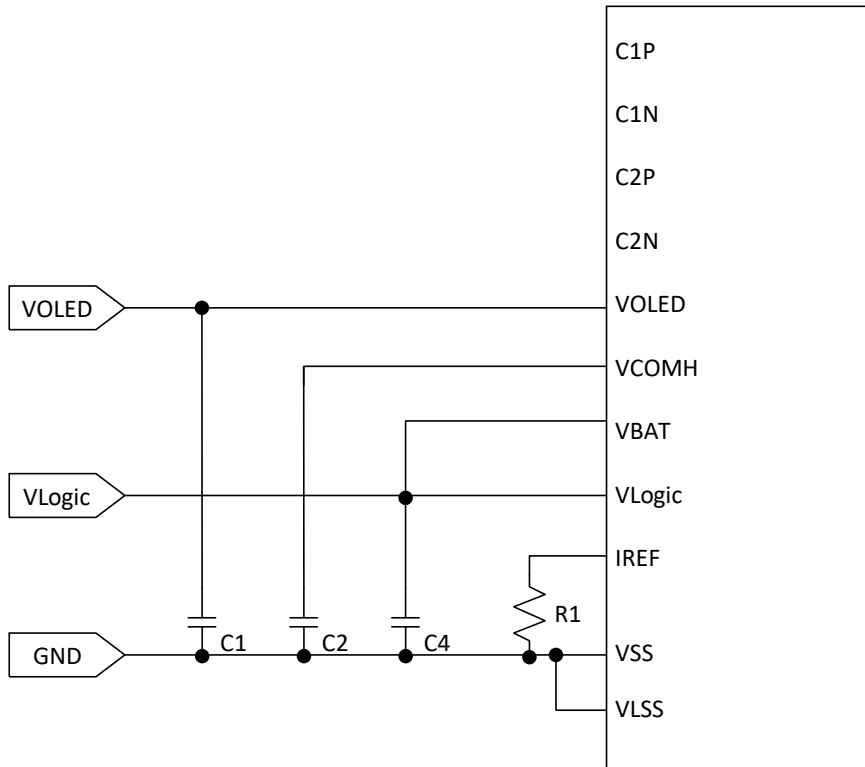
6. Interface Pin Function

Pin No.	Symbol	Function																								
1	GND	Reserved Pin – Connecting this pin to ground can reduce stresses on the function pins.																								
2	C2N	Charge pump regulator capacitor terminals. Connect a 1.0 μ F capacitor between Positive and Negative terminals. The charge pump can generate a 7.5v voltage supply from V _{BAT} to power the OLED driver (V _{OLED})																								
3	C2P																									
4	C1P																									
5	C1N																									
6	V _{BAT}	Power Supply for Charge Pump Circuit If using the charge pump circuit, V _{Logic} < 3.3V < V _{BAT} < 4.2V If not using the charge pump circuit, tie V _{BAT} to V _{Logic}																								
7	NC	No Connection																								
8	V _{SS} (GND)	Ground of Logic Circuit This is a ground pin. It acts as a reference for the logic pins. It must be connected to an external ground.																								
9	V _{Logic}	Power Supply for Logic This is a voltage supply pin. It must be connected to an external source.																								
10	BS0	MCU Interface Selection <table border="1" data-bbox="526 1025 1401 1205"> <thead> <tr> <th></th> <th>BS0</th> <th>BS1</th> <th>BS2</th> </tr> </thead> <tbody> <tr> <td>I²C</td> <td>0</td> <td>1</td> <td>0</td> </tr> <tr> <td>3-Wire SPI</td> <td>1</td> <td>0</td> <td>0</td> </tr> <tr> <td>4-Wire SPI</td> <td>0</td> <td>0</td> <td>0</td> </tr> <tr> <td>8-Bit 6800 Parallel</td> <td>0</td> <td>0</td> <td>1</td> </tr> <tr> <td>8-Bit 8080</td> <td>0</td> <td>1</td> <td>1</td> </tr> </tbody> </table>		BS0	BS1	BS2	I ² C	0	1	0	3-Wire SPI	1	0	0	4-Wire SPI	0	0	0	8-Bit 6800 Parallel	0	0	1	8-Bit 8080	0	1	1
	BS0		BS1	BS2																						
I ² C	0		1	0																						
3-Wire SPI	1		0	0																						
4-Wire SPI	0		0	0																						
8-Bit 6800 Parallel	0	0	1																							
8-Bit 8080	0	1	1																							
11	BS1																									
12	BS2																									
13	CS#	Chip Select Pin. The chip is enabled for MCU communication only when CS# is pulled low.																								
14	RES#	Power Reset for Controller and Driver Initialization of the chip is executed when this pin is low.																								
15	D/C#	Data/Command Control Pin Parallel: When D/C# is high, input at D7-D0 is treated as data. When low, input is transferred to the command register. SPI: When D/C# is high, input at SDIN is treated as data. When low, input is transferred to the command register. I²C: SA0 for slave address selection																								
16	R/W#	Read/Write Select or Write 6800 Parallel: Read/Write Select. Pull this pin High to read or Low to write. 8080 Parallel: Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.																								

Pin No.	Symbol	Function
17	E/RD#	<p>6800 Parallel: Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low.</p> <p>8080 Parallel: Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.</p>
18-25	D0-D7	<p>Parallel: 8-bit bi-directional data bus to be connected to the microprocessor's data bus.</p> <p>SPI: D1 will be the serial data input SDIN and D0 will be the Serial Clock Input SCLK.</p> <p>I2C: D2 & D1 should be tied together and serve as SDA_{OUT} & SDA_{IN} in application and D0 is the Serial Clock Input SCL.</p>
26	I _{REF}	This is the Current Reference Pin for brightness adjustment. A resistor (~300kΩ) should be connected between this pin and V _{SS} . Set the current lower than 12.5μA.
27	V _{COMH}	This is the input pin for the voltage output high level for COM signals. A capacitor (2.2μF) should be connected between this pin and V _{SS} .
28	V _{OLED}	<p>Power Supply for OLED</p> <p>If using the charge pump circuit, connect this pin to GND using a 2.2μF capacitor.</p> <p>If not using the charge pump circuit, V_{OLED} must be supplied externally (~12V)</p>
29	V _{LSS}	<p>Analog Ground Circuit Pin.</p> <p>This pin should be connected to V_{SS} externally.</p>
30	GND	Reserved Pin – Connecting this pin to ground can reduce stresses on the function pins.

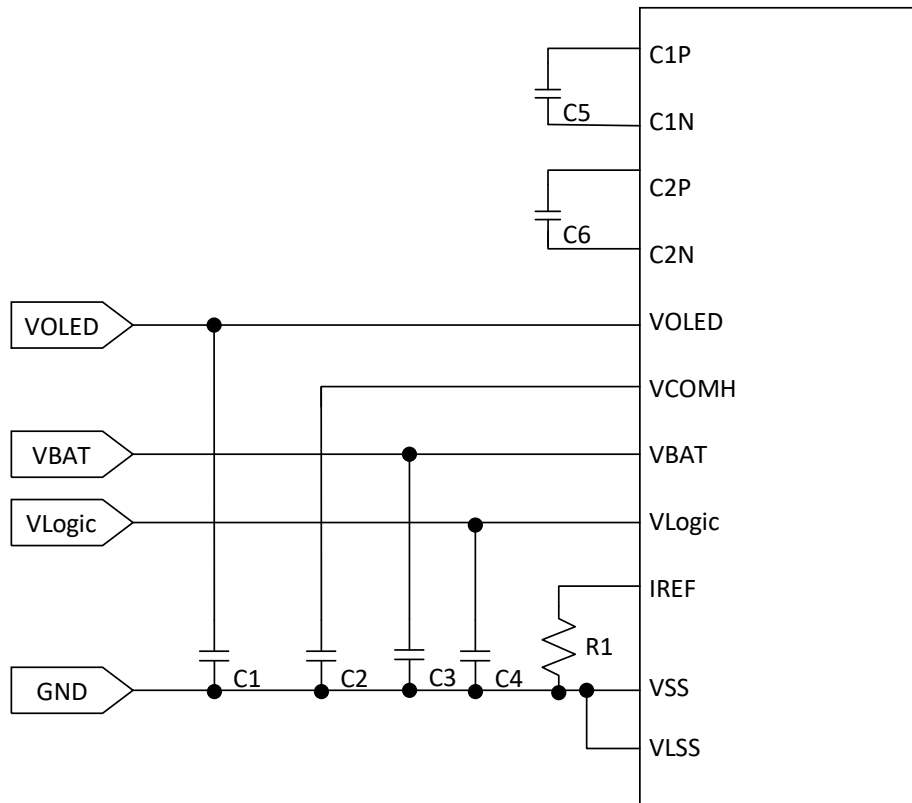
7. Connection Diagrams

7.1. Without Charge Pump Regulator



C1, C2: 2.2 μ F
 C3, C4: 1.0 μ F
 C5, C6: 1.0 μ F/10V

7.2. With Charge Pump Regulator



$R1 = (V_{IREF} - V_{SS}) / I_{REF}$
 $\approx 300k\Omega$

8. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	V _{Logic}	0	3.3	V	(1)(2)
Supply Voltage for Display	V _{OLED}	0	15	V	(1)(2)
Operating Temperature	T _{OP}	-40	+80	°C	-
Storage Temperature	T _{STG}	-40	+85	°C	-

Notes:

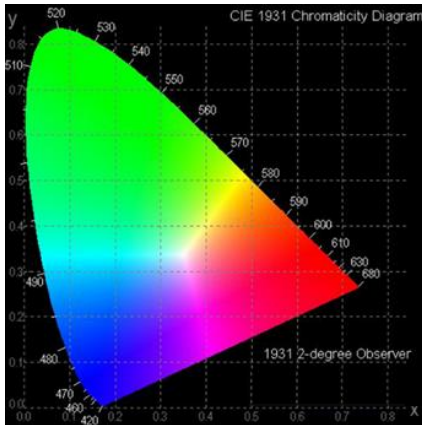
- (1) These are stress ratings only. Extended exposure to the absolute maximum ratings listed above may affect device reliability or cause permanent damage.
- (2) Functional operation should be restricted to the limits in the Electrical Characteristics table below.

9. Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage for Logic	V _{Logic}	-	2.8	3.0	3.3	V
Supply Voltage for Display	V _{OLED}	-	10	12	15	V
Supply Voltage for Charge Pump	V _{BAT}	>V _{Logic}	3.3	-	4.2	V
High-level Input	V _{IH}	-	0.8 x V _{Logic}	-	V _{Logic}	V
Low-level Input	V _{IL}	-	0v	-	0.2 x V _{Logic}	V
High-level Output	V _{OH}	-	0.9 x V _{Logic}	-	V _{Logic}	V
Low-level Output	V _{OL}	-	0v	-	0.1 x V _{Logic}	V
Operating Current	I _{OLED}	V _{OLED} = 12V		9	13.5	mA

10. Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V)θ	Vertical	160	-	-	deg
	(H)φ	Horizontal	160	-	-	deg
Contrast Ratio	CR	Dark	2000:1	-	-	-
Response Time	T rise	-	-	10	-	μs
	T fall	-	-	10	-	μs
Display with 50% Check Board Brightness			60	80	-	cd/m ²
CIE _x Yellow		CIE1931	0.45	0.47	0.49	-
CIE _y Yellow		CIE1931	0.48	0.50	0.52	-
CIE _x Blue		CIE1931	0.12	0.16	0.20	-
CIE _y Blue		CIE1931	0.22	0.26	0.30	-



11. OLED Lifetime

Item	Conditions	Min
Operating Lifetime	$T_a=25^{\circ}\text{C}$ Initial 50% Check Board Brightness Typical Value	20,000 Hrs

Notes:

- (1) Lifetime is defined as the amount of time when the luminance has decayed to <50% of the initial value.
- (2) This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated Probability Density Function (PDF) for the product under normal use conditions.
- (3) Screen saving mode will extend OLED lifetime.

12. OLED Module Precautions

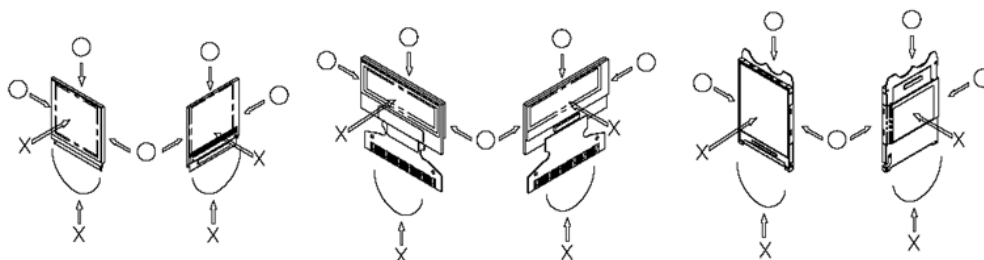
The precautions below should be followed when using OLED modules to help ensure personal safety, module performance, and compliance of environmental regulations.

12.1. Modules

- Avoid applying excessive shocks to module or making any alterations or modifications to it.
- Do not make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- Do not disassemble the OLED display module.
- Do not operate the OLED display module above the absolute maximum rating.
- Do not drop, bend or twist the OLED display module.
- Soldering: only to the I/O terminals.
- Store in an anti-static electricity container and clean environment.
- It is common to use the "screen saver" to extend the lifetime of the OLED display module.
 - Do not use the fixed information for long periods of time in real application.
 - Do not use fixed information in OLED panel for long periods of time to extend "screen burn" effect time.
- Crystalfontz has the right to change the passive components, including R2 and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- Crystalfontz have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance, etc., under the premise of not affecting the electrical characteristics and external dimensions, Crystalfontz has the right to modify the version.)

12.2. Handling Precautions

- Since the display panel is made of glass, do not apply mechanical impacts such as dropping from a high position.
- If the display panel is accidentally broken, and the internal organic substance leaks out, be careful not to inhale or touch the organic substance.
- If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged, so be careful not to apply pressure to these sections.
- The polarizer covering the surface of the OLED display module is soft and can be easily scratched. Please be careful when handling the OLED display module.
- Clean the surface of the polarizer covering the OLED display module if it becomes soiled using following adhesion tape.
 - Scotch Mending Tape No. 810 or an equivalent
 - Never breathe the soiled surface or wipe the surface using a cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
 - The following liquids/solvents may spoil the polarizer:
 - Water
 - Ketone
 - Aromatic Solvents
- Hold the OLED display module very carefully when placing the OLED display module into the system housing.
- Do not apply excessive stress or pressure to the OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, be sure to secure the sufficient rigidity for the outer cases.





- Do not apply stress to the LSI chips and the surrounding molded sections.
- Do not disassemble or modify the OLED display module.
- Do not apply input signals while the logic power is off.
- Pay sufficient attention to the working environments when handling the OLED display module to prevent occurrence of element breakage accidents by static electricity.
 - Be sure to make human body grounding when handling OLED display modules.
 - Be sure to ground tools to use for assembly such as soldering irons.
 - To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
- Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after the film has been removed. In such a case, remove the residue material by the method discussed above.
- If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may become corroded. If this happens proceed with caution when handling the OLED display module.

12.3. Storage Precautions

- When storing the OLED display modules put them in static electricity preventive bags to avoid exposure to direct sunlight and fluorescent lamps. Also avoid high temperature and high humidity environments and low temperatures (less than 0°C) environments. (We recommend you store these modules in the packaged state when they were shipped from Crystalfontz). Be careful not to let water drops adhere to the packages or bags, and do not let dew gather on them.
- If electric current is applied when water drops are adhering to the surface of the OLED display module the OLED display module may have become dewed. If a dewed OLED display module is placed under high humidity environments it may cause the electrodes to become corroded. If this happens proceed with caution when handling the OLED display module.

12.4. Designing Precautions

- The absolute maximum ratings are the ratings that cannot be exceeded for OLED display module. If these values are exceeded, panel damage may happen.
- To prevent occurrence of malfunctioning by noise pay attention to satisfy the V_{IL} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible.
- We recommend that you install excess current preventive unit (fuses, etc.) to the power circuit. (Recommend value: 0.5A)
- Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- As for EMI, take necessary measures on the equipment side.
- When fastening the OLED display module, fasten the external plastic housing section.
- If the power supply to the OLED display module is forcibly shut down, by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
 - Connection (contact) to any other potential than the above may lead to rupture of the IC.

12.5. Disposing Precautions

- Request the qualified companies to handle the industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

12.6. Other Precautions

- When an OLED display module is operated for a long period of time with a fixed pattern, the fixed pattern may remain as an after image or a slight contrast deviation may occur.
 - If the operation is interrupted and left unused for a while, normal state can be restored.
 - This will not cause a problem in the reliability of the module.



- To protect the OLED display module from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
 - Pins and electrodes
 - Pattern layouts such as the TCP & FPC
- With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
 - Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
 - Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. Therefore, it is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- We recommend that you construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data), to cope with catastrophic noise.
- Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier.
- Crystalfontz has the right to upgrade and modify the product function.
- The limitation of FPC bending:

